Seat No.:	Enrolment No.

## GUJARAT TECHNOLOGICAL UNIVERSITY ME SEMESTER - IV (NEW) EXAMINATION – SUMMER 2017

Date:03/05/2017

Subject Code: 2740503

**Subject Name: MICROWAVE INTEGRATED CIRCUITS** Time: 02:30 pm to 05:00 pm **Total Marks: 70 Instructions:** 1. Attempt all questions. 2. Make suitable assumptions wherever necessary. 3. Figures to the right indicate full marks. (a) What do you understand by thick and thin film technologies? And explain any **Q.1** 07 one technology. List the advantage of MICs compared to traditional circuits using printed circuit 07 technology. (a) Explain the Branch line couplers. 07 0.2 Explain fabrication process of MMICS? 07 OR (b) What are the differences between the Hybrid and Monolithic MICs. **07** 0.3 (a) Differentiate distributed elements and lumped elements? 07 **(b)** Discuss the various losses in microstrip. 07 Explain the operation HEMT and V/I characteristics. Q.3 (a) 07 Write method of full wave analysis of microstrip line and explain any one. 07 **(b) 07 Q.4** (a) Explain quasi-static line (Microstrip) parameters, (Eeff, zo, w/h ratio) Explain microstrip directional coupler with appropriate equation and find the **(b)** 07 value of Zoe and Zoo, when coupling factor = -10dB. OR 0.4 (a) Explain the narrow band filter using coupler resonator. **07** Give the answer of following question in two to three lines 07 What is mean by Periodic branch line coupler? (i) (ii) Write the Disadvantage of coupled line. 0.5 What distinguishes RF / Microwave packages from low frequency or digital **07** packages? And explain basic circuit design goals. (b) Explain the working of gunn diode, varactor diode and PIN diode **07** OR (a) Describe the small signal equivalent circuit of MESFET (Metal Semiconductor **Q.5** 07 Field Effect Transistors) **(b)** Give the ideal characteristics of following materials: 07 Substrate materials (i) (ii) Conductor materials

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